

Top View

# N-Channel 150 V (D-S) 175 °C MOSFET

# PowerPAK® SO-8DC

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	150			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0079			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.0085			
Q <sub>g</sub> typ. (nC)	35.1			
I <sub>D</sub> (A)	90.9			
Configuration	Single			

**Bottom View** 

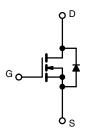
#### **FEATURES**

- TrenchFET® Gen V power MOSFET
- Very low R<sub>DS</sub> Q<sub>g</sub> figure-of-merit (FOM)
- $\bullet$  Tuned for the lowest  $R_{DS}$   $Q_{oss}$  FOM
- 100 % R<sub>a</sub> and UIS tested
- · Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

# HALOGEN **FREE**

#### **APPLICATIONS**

- · Synchronous rectification
- · Primary side switch
- DC/DC converters
- · OR-ing and hot swap switch
- Power supplies
- · Motor drive control
- · Battery management



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8DC
Lead (Pb)-free and halogen-free	SiDR570EP-T1-RE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	150	V	
Gate-source voltage		V <sub>GS</sub>	± 20		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		90.9 <sup>a</sup>		
	T <sub>C</sub> = 70 °C	1 . F	76 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	30.8 b, c		
	T <sub>A</sub> = 70 °C	1 -	25.8 <sup>b, c</sup>		
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	200	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		136		
	T <sub>A</sub> = 25 °C	ls –	6.8 <sup>b, c</sup>		
Single pulse avalanche current	. 0.1	I <sub>AS</sub>	30		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	45	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		150		
	T <sub>C</sub> = 70 °C	1 ,	105	14/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	7.5 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C	†	5.25 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175		
Soldering recommendations (peak temperature) d, e			260	°C	

#### **Notes**

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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# Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, b	t ≤ 10 s	$R_{thJA}$	15	20		
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	0.8	1	°C/W	
Maximum junction-to-case (source)	Steady state	$R_{thJC}$	1.1	1.4		

#### **Notes**

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 54 °C/W

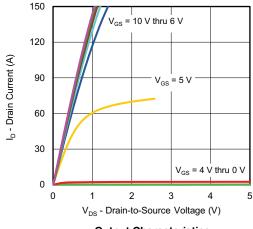
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	150	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	125	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-6.9	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	-	4	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	100	nA	
Zero gate voltage drain current		V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V	-	-	1	μА	
	I <sub>DSS</sub>	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15		
Drain-source on-state resistance <sup>a</sup>	Б	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	0.0065	0.0079	Ω	
	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, I_D = 20 \text{ A}$	-	0.0070	0.0085		
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A	-	80	-	S	
Dynamic <sup>b</sup>					<u> </u>		
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	3740	-	pF	
Output capacitance	C <sub>oss</sub>		-	330	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	6.5	-		
Talal calculations		$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	46.9	71	nC	
Total gate charge	Qg		-	35.1	53		
Gate-source charge	Q <sub>qs</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 7.5 \text{ V}, I_{D} = 20 \text{ A}$	-	18.1	-		
Gate-drain charge	Q <sub>gd</sub>		-	4.2	-		
Output charge	Q <sub>oss</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$	-	111	-		
Gate resistance	$R_q$	f = 1 MHz	0.4	1.1	1.8	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	17	34		
Rise time	t <sub>r</sub>	$V_{DD} = 75 \text{ V}, R_1 = 3.75 \Omega, I_D \cong 20 \text{ A},$	-	16	32		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	29	58	1	
Fall time	t <sub>f</sub>		-	21	42	1	
Turn-on delay time	t <sub>d(on)</sub>		-	21	42	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 75 \text{ V}, R_L = 3.75 \Omega, I_D \cong 20 \text{ A},$	-	74	148	- - -	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$	-	27	54		
Fall time	t <sub>f</sub>		-	22	44		
<b>Drain-Source Body Diode Characterist</b>	ics		•				
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C -	-	136			
Pulse diode forward current	I <sub>SM</sub>		-	-	200	_ A	
Body diode voltage	$V_{SD}$	I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V	-	0.75	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	84	168	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	221	442	nC	
Reverse recovery fall time	ta	$T_J = 25  ^{\circ}C$	-	65	-	ns	
Reverse recovery rise time	t <sub>b</sub>		_	19	_		

#### Notes

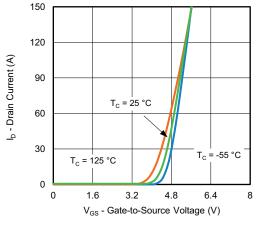
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

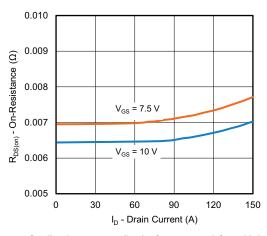




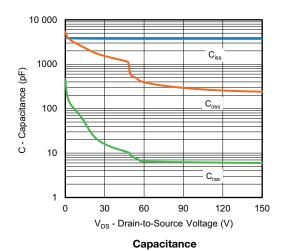


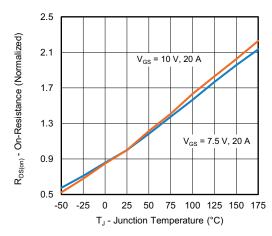


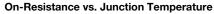
**Transfer Characteristics** 

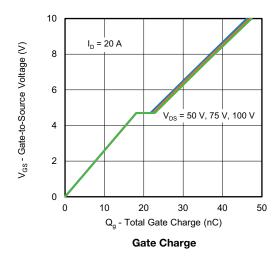


On-Resistance vs. Drain Current and Gate Voltage

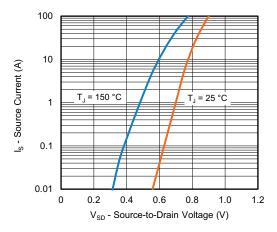




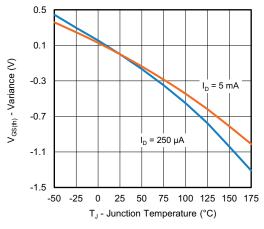




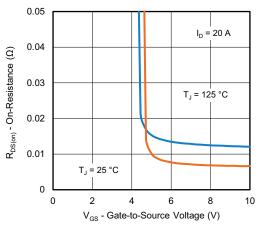




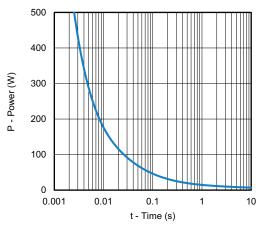
Source-Drain Diode Forward Voltage



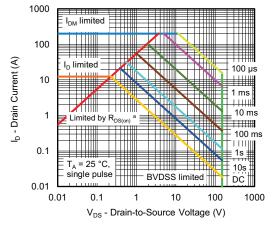
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

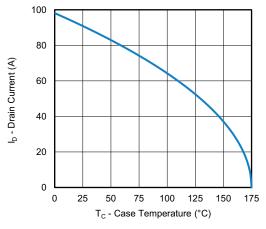


Single Pulse Power, Junction-to-Ambient



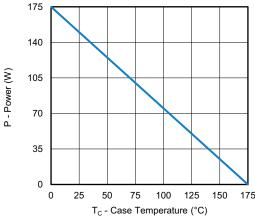
Safe Operating Area, Junction-to-Ambient

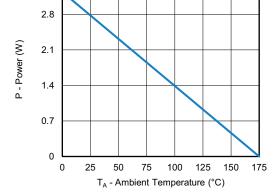




Current Derating a

3.5





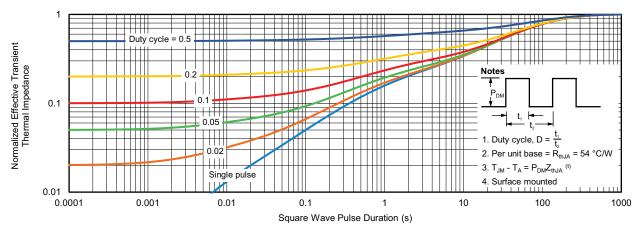
Power, Junction-to-Case

Power, Junction-to-Ambient

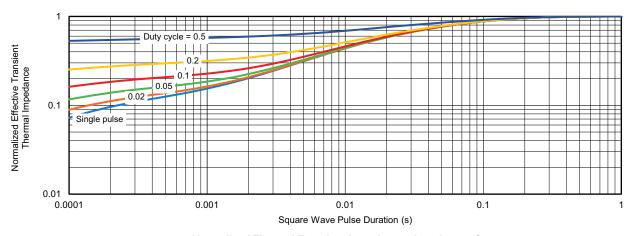
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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